



深圳市锐硕光电有限公司

Shenzhen Ruishuo Optoelectronic Co.,Ltd

SPECIFICATIONS FOR T3C SERIES

WHITE LED

Model : 3030

Part No : T3C***21S-R****

Features:

- * Top view white LED
- * Thermally Enhanced Package Design
- * High luminous flux output
- * High current capability
- * Compact Package Size
- * Wide viewing angle
- * Pb-free Reflow Soldering Application
- * The product itself will remain within RoHS compliant version

**Applications**

- * Retrofits(replacement)
- * General lighting
- * Indoor & Outdoor sign board back light
- * Architectural / Decorative lighting

Part Numbering System

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X1 X2 X3 X4 X5 X6 X7 X8 X9 X10

Item Number Code	Description	Content
X1	Type code	1S:1010; 1A:1919; 20:2016; 3B:3014; 28:2835 34:3020; 3C:3030; 5C:5050; 7C:7070; 1D:100100; 19:Ceramic 3535; 15:Ceramic 5050; 11:Ceramic 1616.
X2	CCT code	2700K:27; 3000K:30; 4000K:40; 5000K:50; 5700K:57; 6500K:65; RE:Red;GR:Green;BL:Blue;YE:Yellow; PA:PC Amver;IR: Infrared;
X3	Color Rendering	Ra70:7; Ra80:8; Ra90:9.
X4	No. of serial chip	1-Z.
X5	No. of parallel chip	1-Z.
X6	Component code	A-Z.
X7	Color Code	M:ANSI; F:ERP; R:85 ANSI; T:105 ANSI; B:Backlighting; Q:Others;
X8	Internal code1	\
X9	Internal code2	\
X10	Spare code	\

Electro Optical Characteristics, IF = 120mA, Tj=25

CCT	Color Rendering	Luminous Flux	
	Min.	Typ.	Min.
2700K	70	118	110
	80	111	105
	90	94	85
3000K	70	123	115
	80	116	110
	90	98	90
4000K	70	129	120
	80	123	115
	90	104	95
5000K	70	129	120
	80	123	115
	90	104	95
5700K	70	129	120
	80	123	115
	90	104	95
6500K	70	129	120
	80	123	115
	90	104	95

* Tolerance of measurements of the Luminous Flux is $\pm 7\%$.

* Ra measurement tolerance is ± 2 .

Absolute Maximum Ratings at Tj=25

Item	Symbol	Absolute Maximum Rating	Unit
Forward current	IF	200	mA
Pulse Forward current	IFP	300	mA
Power Dissipation	PD	1280	mW
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-40~+105	
Storage Temperature	Tstg	-40~+85	
Junction Temperature	Tj	120	
Soldering Temperature	Tsld	Reflow Soldering 230 or 260 for 10sec	

* IFP condition with Pulse: Width≤100μs, Duty cycle≤1/10.

* LED's properties might be different from suggested values like above and below tables if operation condition will be exceeded our parameter range. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.

* All measurements were made under the standardized environment of Lightning LED.

Electrical/Optical Characteristics at Tj=25

Item	Symbol	Min	Typ	Max	Unit	Condition
Forward Voltage	VF	5.6	5.9	6.4	V	IF = 120mA
Reverse Current	IR	-	-	10	μA	VR=5V
Viewing Angle	2θ1/2	-	120	-	°	IF = 120mA
Thermal Resistance	(Rth j-sp)	-	13	-	/W	IF = 120mA
Electrostatic Discharge	ESD	1000	-	-	V	HBM

* Tolerance of measurements of the Forward Voltage is ±0.2V.

* 2θ1/2 is the off-axis where the luminous intensity is 1/2 of the peak intensity.

* Rth j-sp is the thermal resistance from LED junction to solder point on MCPCB with electrical power.

Bin Structure

Luminous Flux Ranks, IF = 120mA, Tj =25

CCT	Color Rendering		Luminous Flux		
	Min.	Typ.	Code	Min	Max
2700K	70	72	5G	110	115
			5H	115	120
			5J	120	125
			5K	125	130
	80	82	5F	105	110
			5G	110	115
			5H	115	120
			5J	120	125
	90	92	5B	85	90
			5C	90	95
			5D	95	100
			5E	100	105
3000K	70	72	5H	115	120
			5J	120	125
			5K	125	130
			5L	130	135
	80	82	5G	110	115
			5H	115	120
			5J	120	125
			5K	125	130
	90	92	5C	90	95
			5D	95	100
			5E	100	105
			5F	105	110
4000K/5000K/ 5700K/6500K	70	72	5J	120	125
			5K	125	130
			5L	130	135
			5M	135	140
	80	82	5H	115	120
			5J	120	125
			5K	125	130
			5L	130	135
	90	92	5D	95	100
			5E	100	105
			5F	105	110
			5G	110	115

* Tolerance of measurements of the Luminous Flux is $\pm 7\%$.

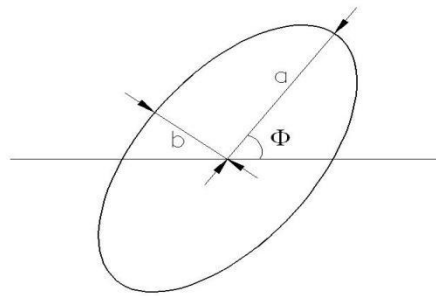
* Ra measurement tolerance is ± 2 .

Forward Voltage Ranks, IF = 120mA, Tj =25

Code	Min	Max	Unit
Z3	5.6	5.8	V
A4	5.8	6.0	V
B4	6.0	6.2	V
C4	6.2	6.4	V

* Tolerance of measurements of the Forward Voltage is $\pm 0.2V$.

CIE Chromaticity Diagram, IF = 120mA, Tj = 25



The color ranks have chromaticity ranges within 5-step MacAdam ellipse

Color Code	Tj=25		Center Tj=85		Radius		Angle(deg)
	x	y	x	y	a	b	Φ
27R5	0.4620	0.4145	0.4578	0.4101	0.013500	0.007000	53.42
30R5	0.4383	0.4081	0.4338	0.4030	0.013900	0.006800	53.13
40R5	0.3875	0.3868	0.3818	0.3797	0.015650	0.006700	53.43
50R5	0.3507	0.3635	0.3447	0.3553	0.013700	0.005900	59.37
57R5	0.3348	0.3491	0.3287	0.3417	0.011175	0.005500	58.35
65R5	0.3187	0.3363	0.3123	0.3282	0.011150	0.004750	58.34

* Energy Star binning applied to all 2600~7000K.

* Tolerance of measurements of the chromaticity Coordinate is ± 0.005 .

Fig 1. Color Spectrum, $T_j =$ $Ra \geq 70$

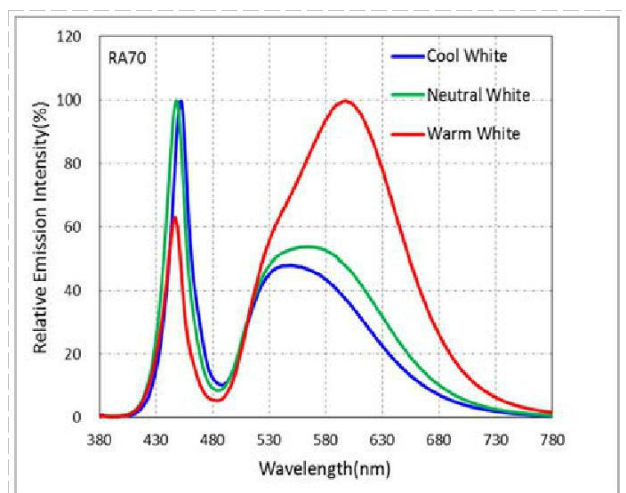


Fig 2. Color Spectrum, $T_j = 25$ $Ra \geq 80$

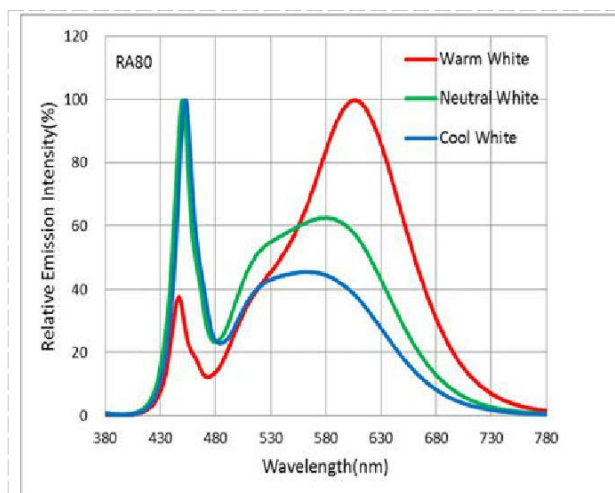


Fig 3. Color Spectrum, $T_j = 25$ $Ra \geq 90$

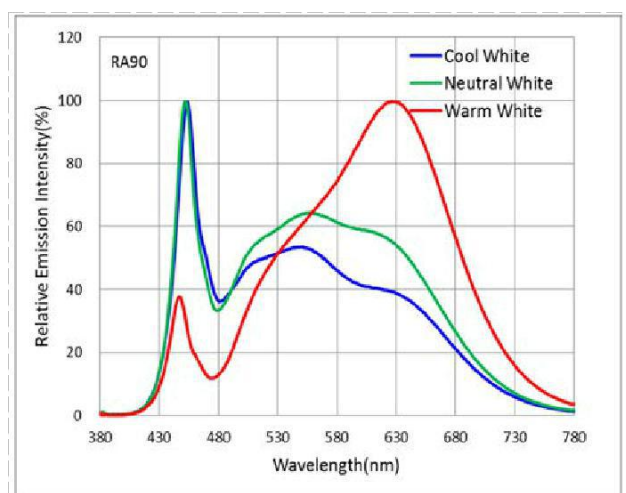


Fig 4. Viewing Angle Distribution, $T_j = 25$

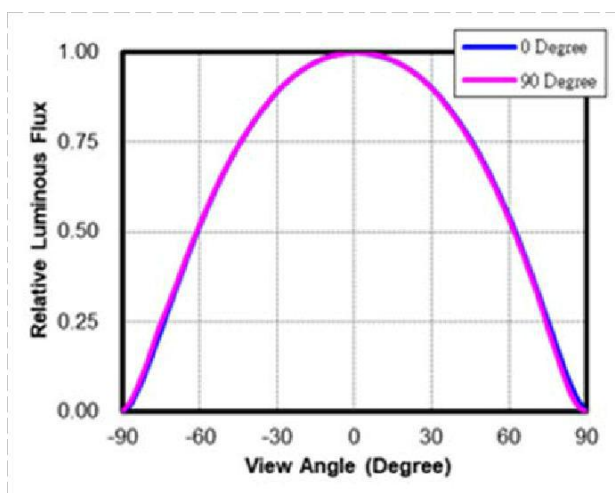


Fig5. Forward Current vs. Relative Intensity, $T_j = 25$

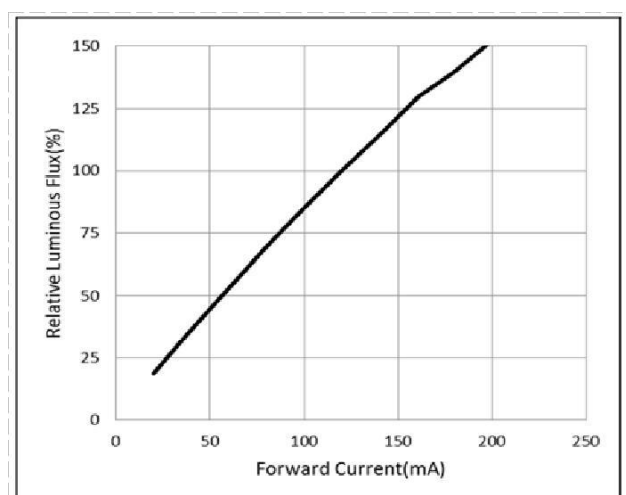


Fig . Forward Current vs. Forward Voltage, $T_j = 25$

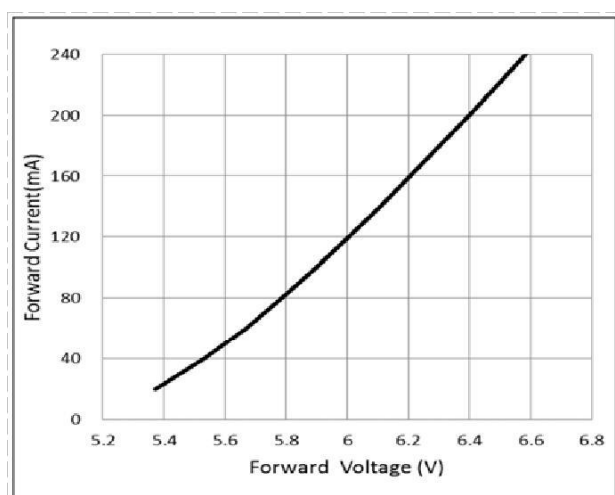


Fig 7. Ambient Temperature vs. Relative Luminous flux (IF=120mA)

Fig 8. Ambient Temperature vs. Relative Forward Voltage (IF=120mA)

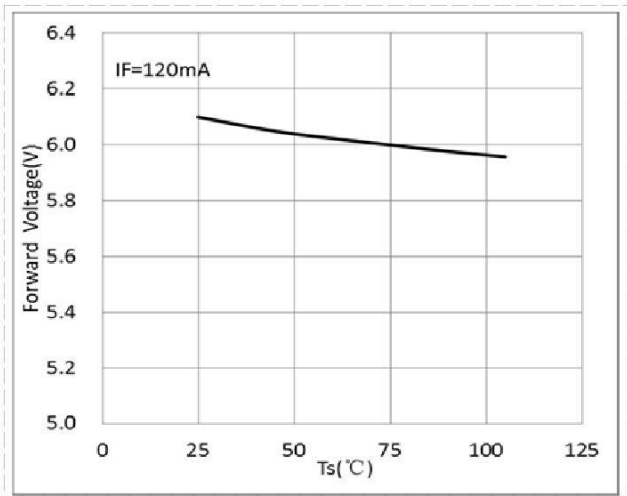
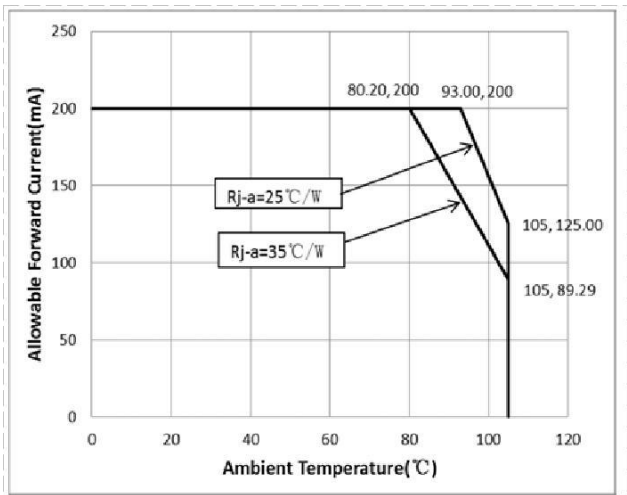
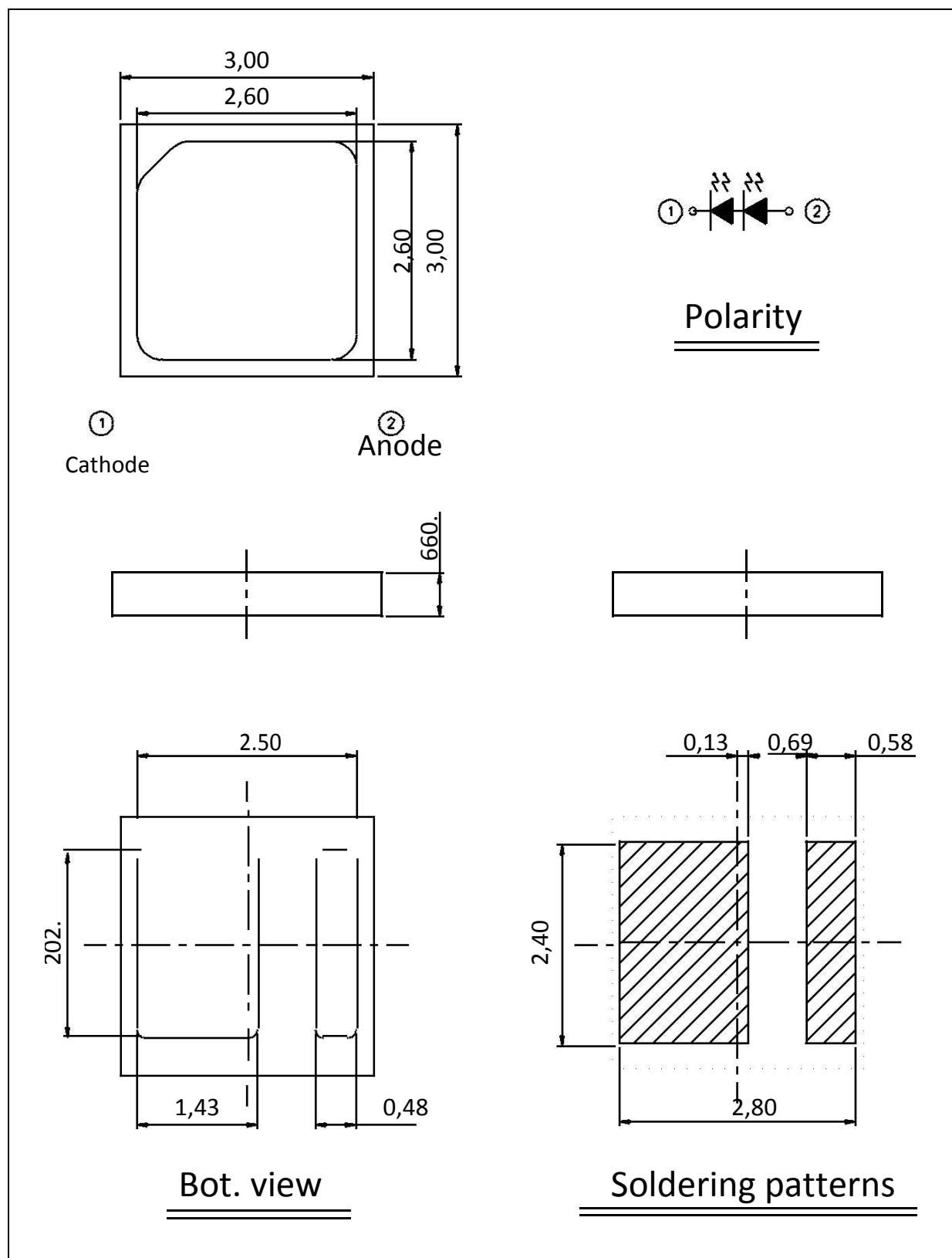


Fig 9. Ts vs. CIE x, y Shift

Fig10.Maximum Forward Current vs. Ambient Temperature

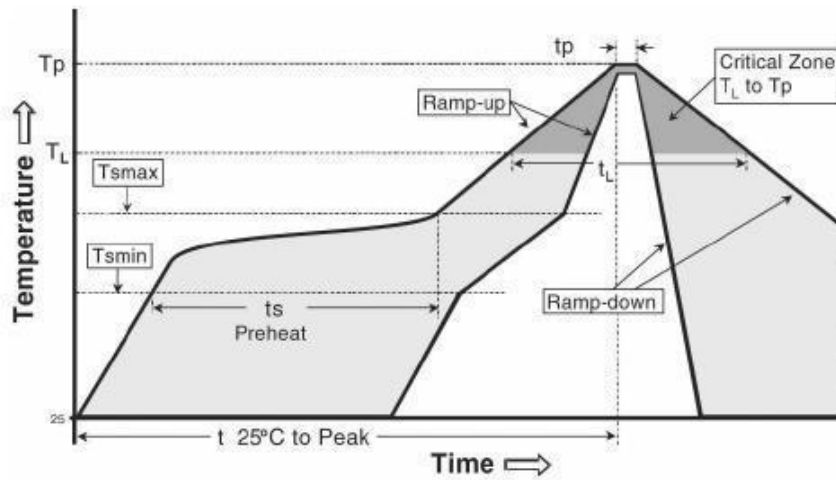


Package Dimensions



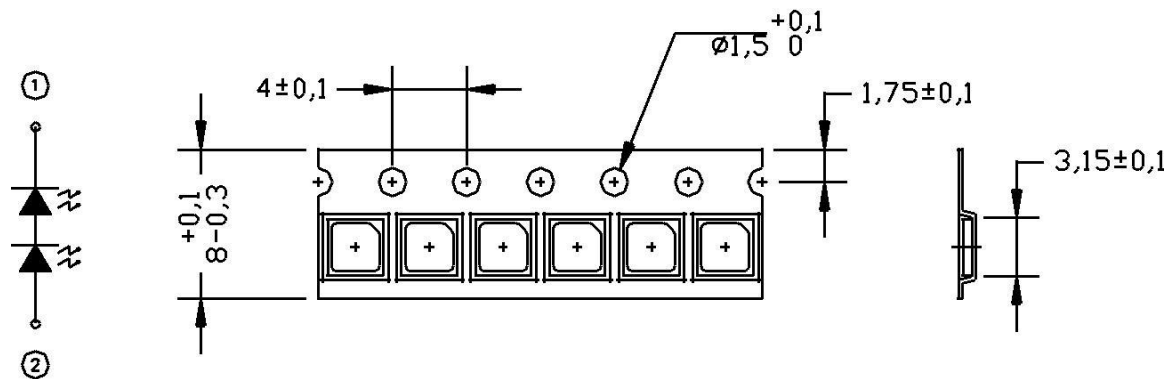
* The tolerance unless mentioned is $\pm 0.2\text{mm}$, unit = mm

Reflow Soldering Characteristics



Reflow soldering	
Temperature Min (Tsmin)	150° C
Temperature Max (Tsmax)	200° C
Time(ts)from (Tsmin to Tsmax)	60-120 seconds.
Ramp-up rate (TL to Tp)	3° C/seconds max.
Liquidous temperature(TL)	217° C
Time(tL) maintained above TL	60-150 seconds
Peak package body temperature(Tp)	260° C max
Time (tp) within 5° C of the specified classification temperature (Tc).	30 seconds max
Ramp-down rate (Tp to TL)	6° C/second max
Time 25 ° C to peak temperature	8 min max

Package Dimensions of Tape



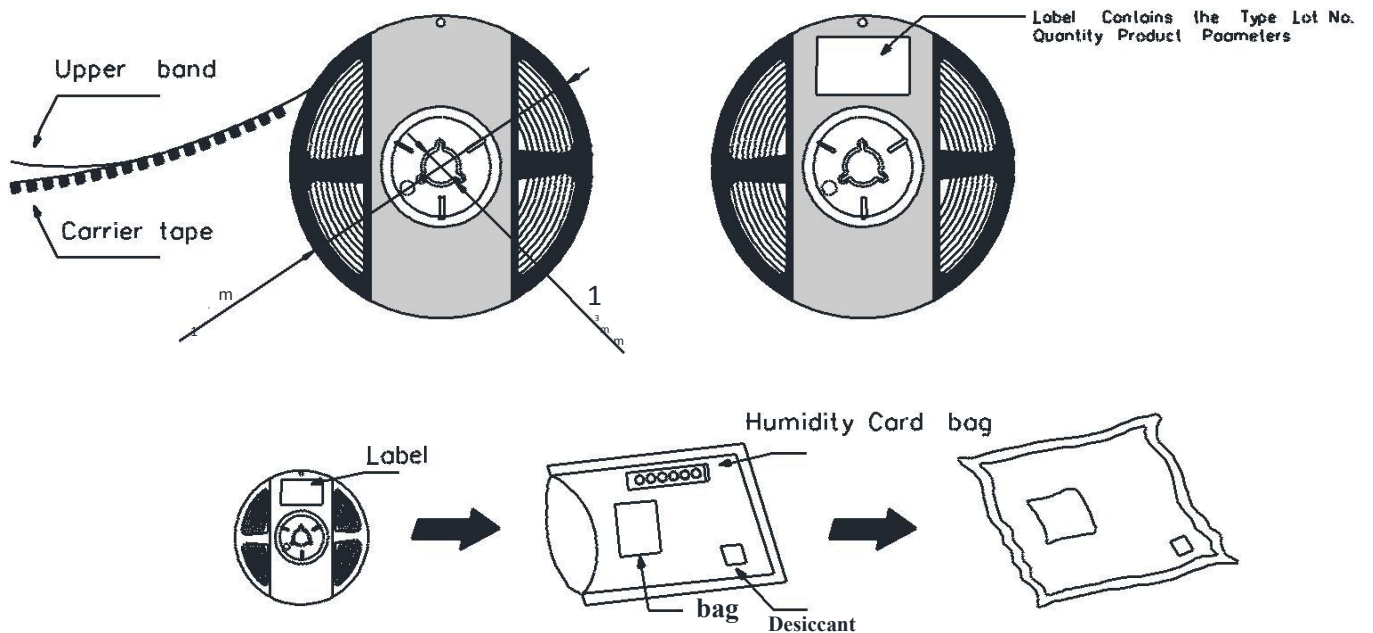
* Quantity : Max 5000pcs/Reel

* Cumulative Tolerance : Cumulative Tolerance/10 pitches to be $\pm 0.2\text{mm}$

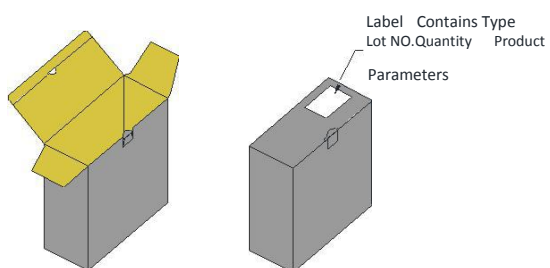
* Package : P/N, Manufacturing data Code No. and Quantity to be indicated on a damp proof Package.

* unit = mm

Package Dimensions of Reel

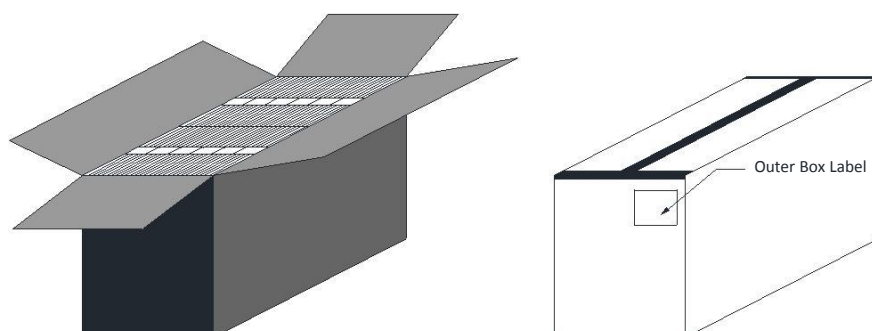


Package Box



* Capacity 10 reels per box.

Outer Box



* Capacity 30 or 60 reels per box.

Label

Caution

1. Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
2. Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
3. Die slug is to be soldered.
4. When soldering, do not put stress on the LEDs during heating.
5. After soldering, do not warp the circuit board.

Notes on Lightning EMC Series soldering:

1. Recommend to use reflow machine.
2. Recommend to use heating plate soldering.
3. Manual soldering is not recommended.

Notes on reflow process:

1. To confirm whether the actual temperature curve in the reflow soldering conditions comply with recommended conditions. LEDs are guaranteed for one time reflow.
2. During reflow process do not apply force on LED active area.
3. After reflow process, PCB board should be cooled down before packing or storage.

Precaution for use

Storage

1. Before opening the package: The LED should be kept at 5 ~30 °C and 60%RH or less.
2. After opening the package: The LED's floor life is 168Hrs under 30 °C or less and 60%RH or less. If unused LED remain, it should be stored in moisture proof packages JEDEC (MSL 3).
3. If the moisture absorbent material(silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions : Baking treatment: 60±5 °C for 24 hours.